Challenges in High-Tech, illustrated in the medical domain

by Gerrit Muller Buskerud University College

e-mail: gaudisite@gmail.com

www.gaudisite.nl

Abstract

A short description is given of the medical domain, which is used to illustrate what technical challenges are present in high-tech development organizations.

A top list of technical challenges: Market dynamics, reliability, interoperability, security, power and creativity is presented and every challenge is briefly discussed.

The potential roles for new technical people are described and the future career possibilities.

Distribution

This article or presentation is written as part of the Gaudí project. The Gaudí project philosophy is to improve by obtaining frequent feedback. Frequent feedback is pursued by an open creation process. This document is published as intermediate or nearly mature version to get feedback. Further distribution is allowed as long as the document remains complete and unchanged.

June 23, 2016 status: concept

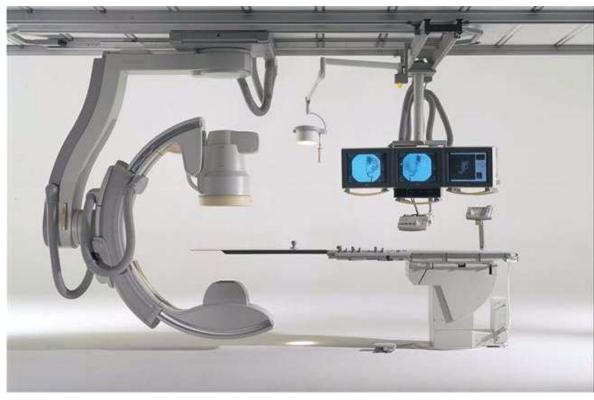
version: 1.0



Conventional X-ray systems

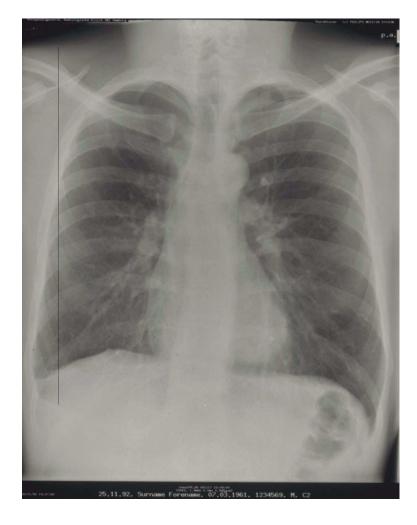


EasyDiagnost URF



Integris Allura Cardio-Vascular

Typical X-ray results



Thorax rad-image



Cardio Vascular images on monitors

Magnetic Resonance Imaging, MRI scanners



Intera MR scanner



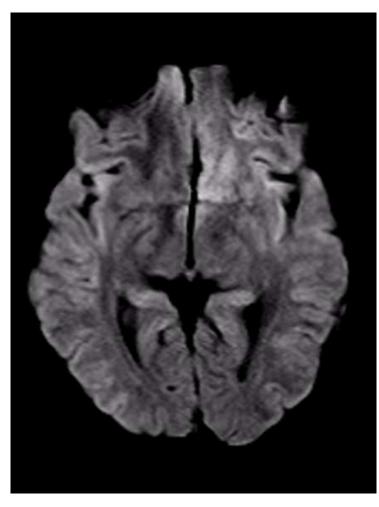
Gyroscan NT



Results from CT and MRI scanners



virtual endoscopy based on CT images



MRI image of the brain

Hit list of challenges

discover latent needs enable emergence where is the business

creativity

globalization hype waves Moore's law

market dynamics

security

privacy, DRM versus usability

interoperability

emerging behavior, future vs legacy heterogeneous vendors

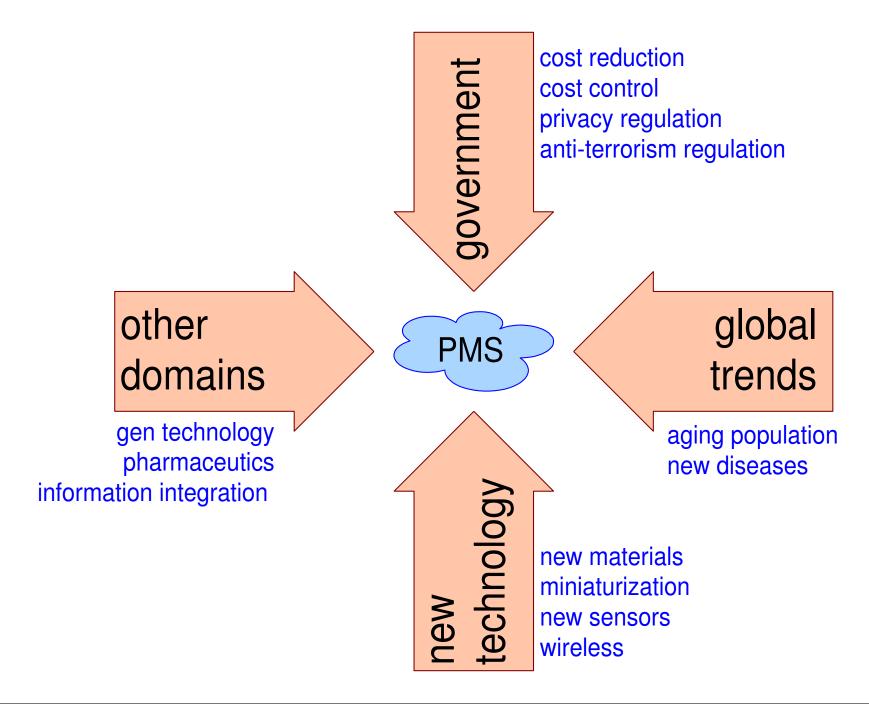
power consumption

weight, cost, performance

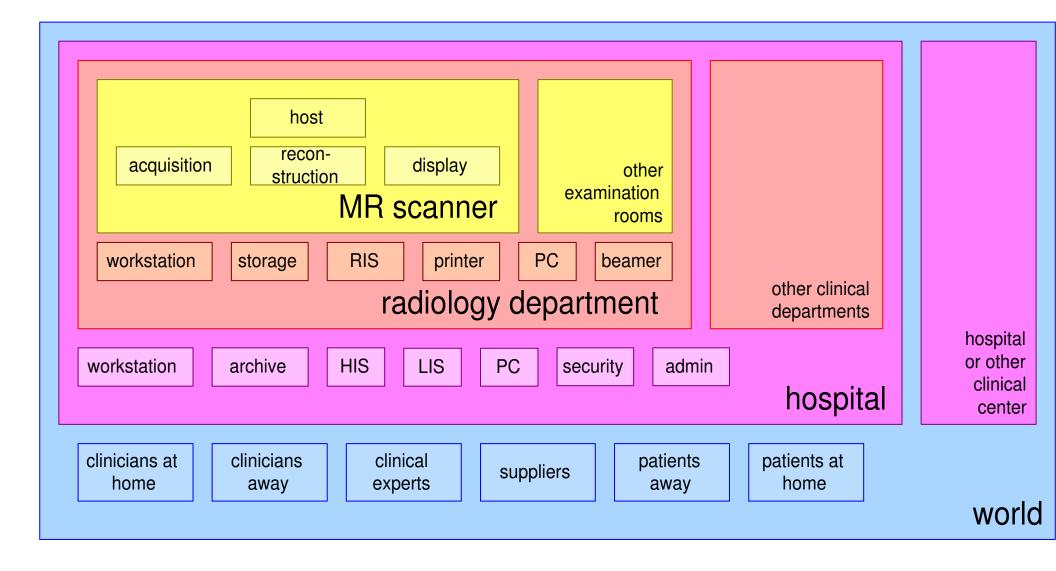
reliability

heterogeneity
#engineers involved

Market dynamics in medical



Interoperability: systems get connected at all levels



Multi dimensional interoperability

integrating multiple

applications

cilinical analysis clinical support administrative financial workflow in **multiple**

languages cultures

USA, UK, China, India, Japan, Korea France, Germany Italy, Mexico delivered by multiple

vendors

Philips GE Siemens

based on **multiple**

media, networks

DVD+RW
memory stick
memory cards
bluetooth
11a/b/g
UTMS

and multiple

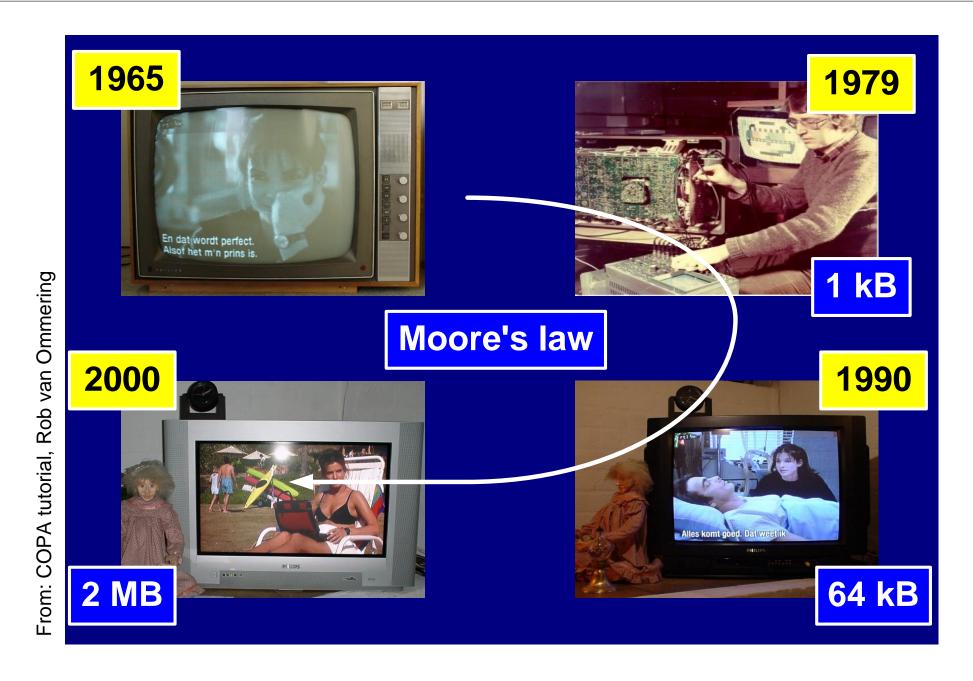
standards

Dicom HL7 XML and multiple

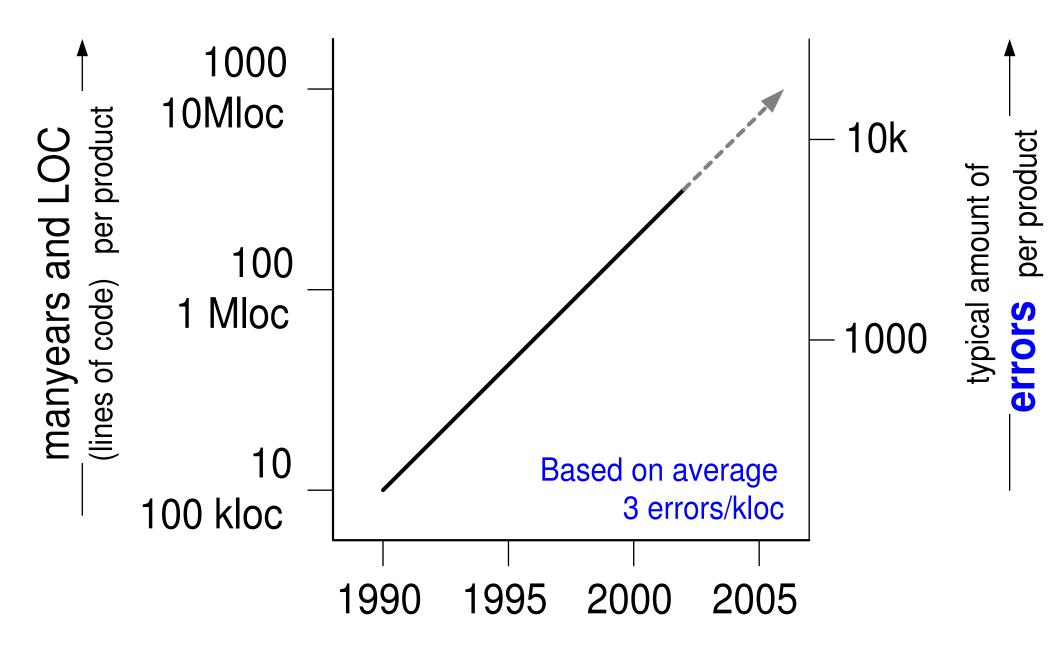
releases

R5 R6.2 R7.1

SW increase in televisions



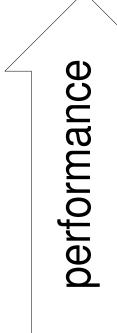
Increase of software threatens Reliability



Power consumption and dissipation

heat dissipation stand by time operational time acoustic noise power supply cost





faster more

3G phone standby time operational time wireless video

examples

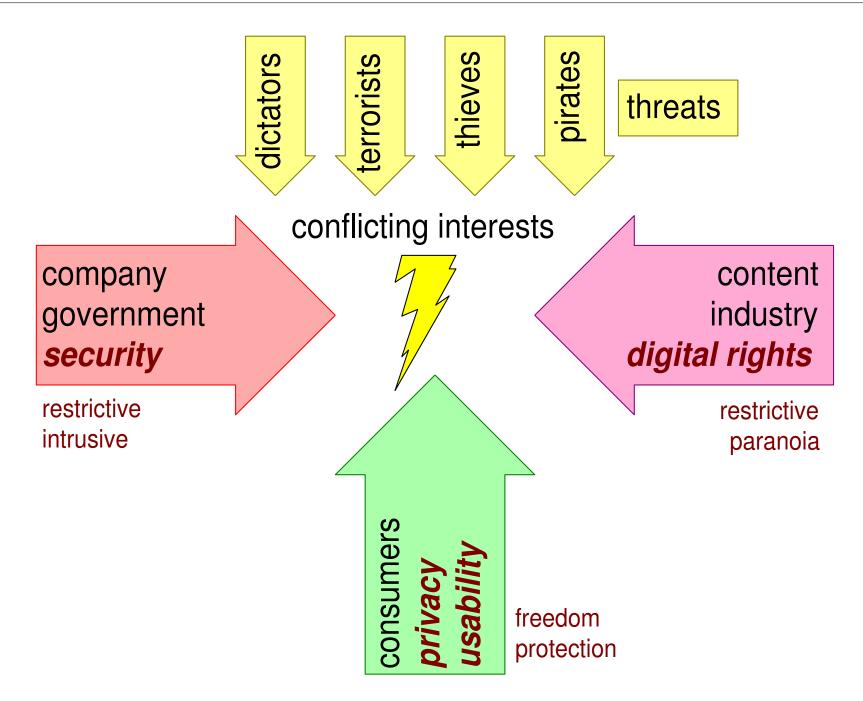
desktop silent fanless

data centers insufficient power in **Amsterdam**

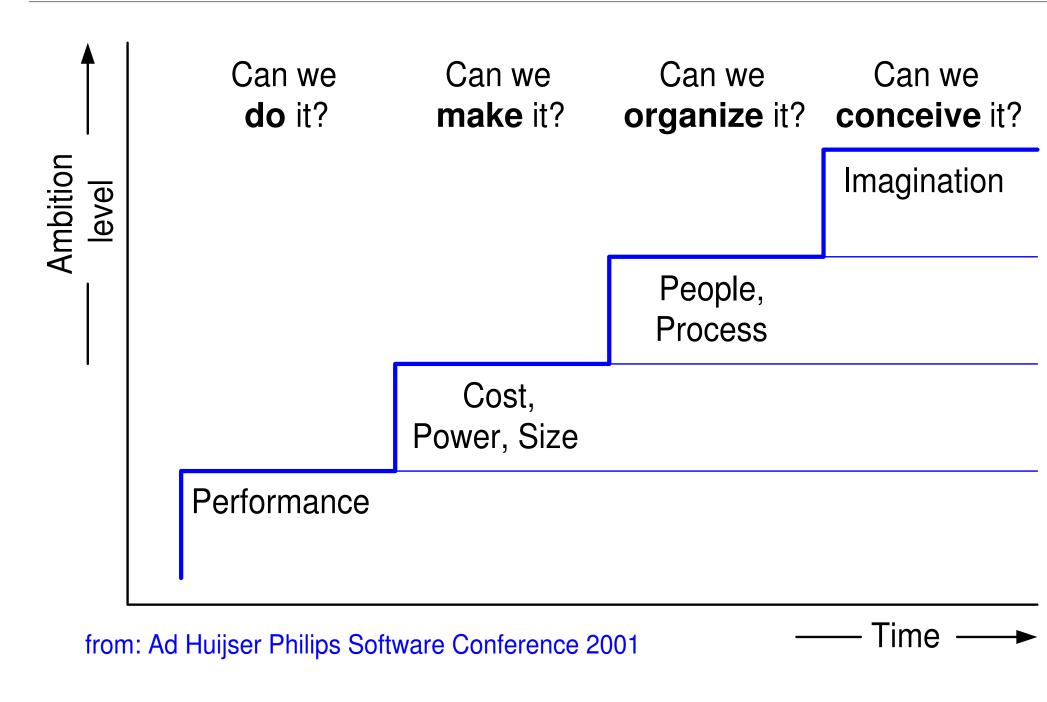
MRI gradients: 66 mT/m

kWatts: cost, noise, heat

Security conflicting interests



Creativity as limiting factor



version: 1.0 June 23, 2016

DYOFcreativity

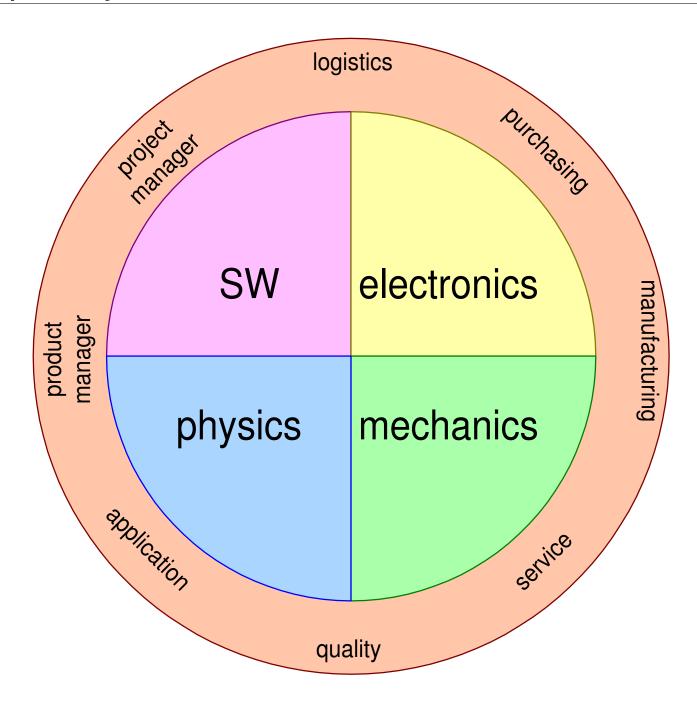


version: 1.0 June 23, 2016

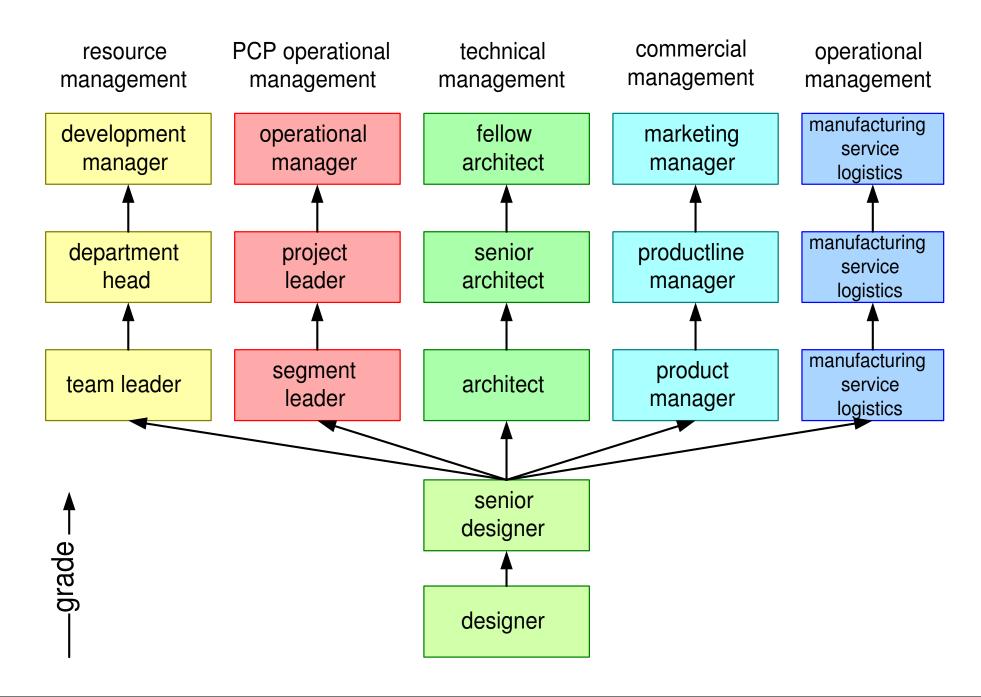
DYOFuncleSam

NEAREST RECRUITING STATION

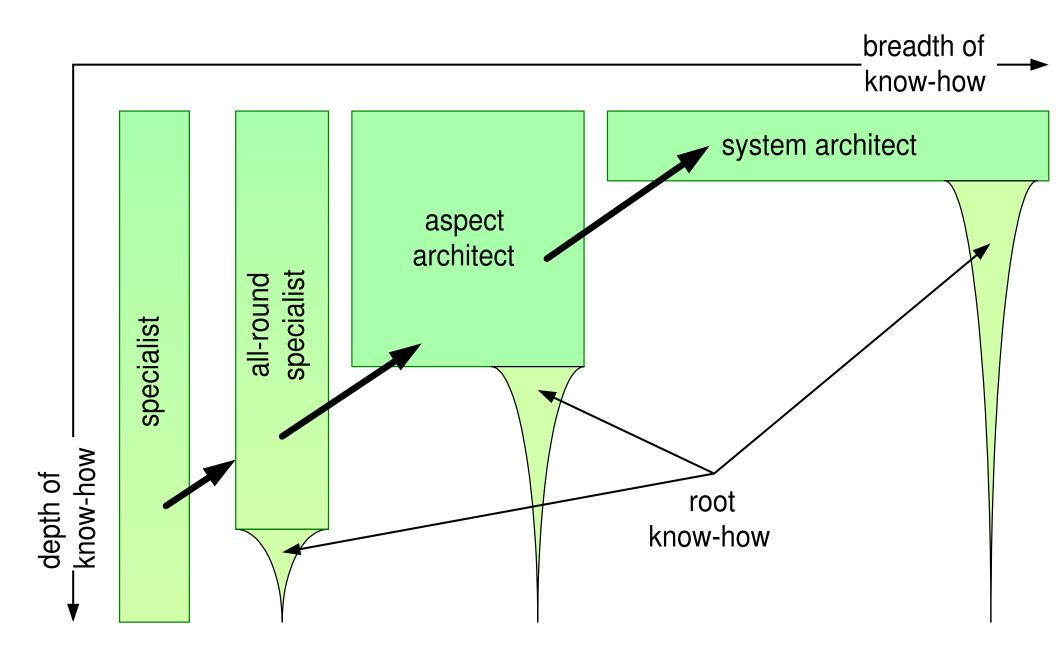
Multi disciplinary teamwork



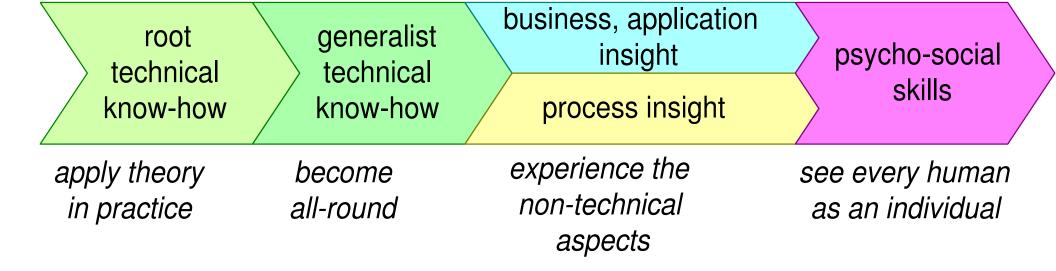
Multi ladder career paths



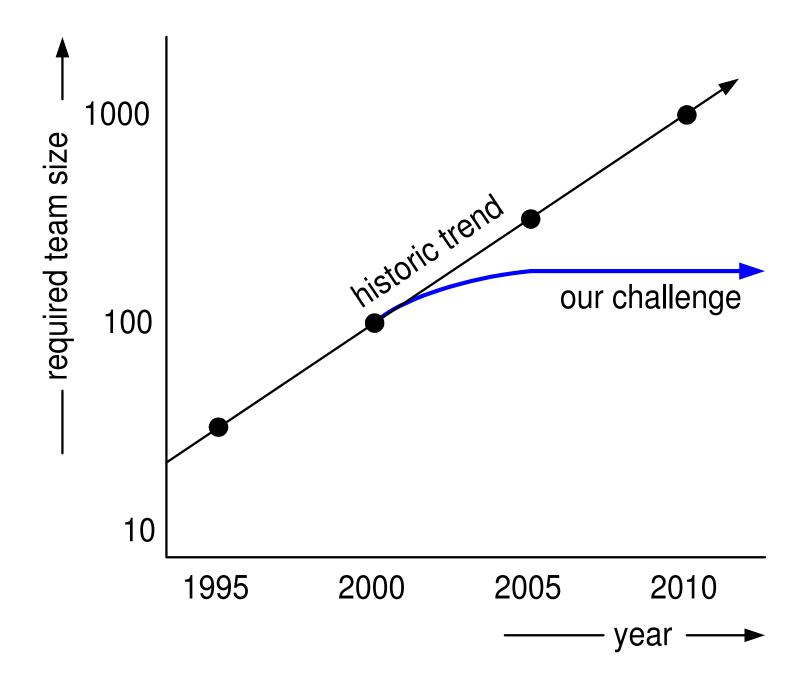
Technical specialists and generalists are needed



Growth Path Architect



More designers are needed all the time (unless..)



Use your brains to **Design Your Own Future**



We can use your brains!